



## N-Channel Enhancement-Mode Vertical DMOS Power FETs

### Ordering Information

$BV_{DSS}$ / $BV_{DGS}$	$R_{DS(ON)}$ (max)	$I_{D(ON)}$ (min)	Order Number / Package			
			TO-3	TO-39	TO-220	Dice
450V	4Ω	2A	VN0345N1	VN0345N2	VN0345N5	VN0345ND
500V	4Ω	2A	VN0350N1	VN0350N2	VN0350N5	VN0350ND

### Features

- Freedom from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low  $C_{ISS}$  and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-Channel devices

### Advanced DMOS Technology

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and negative temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

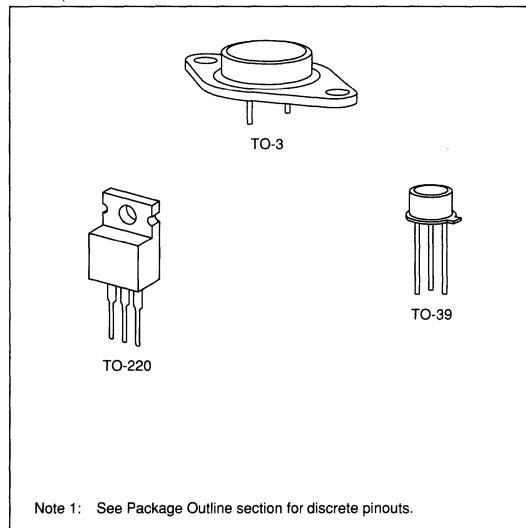
Supertex Vertical DMOS Power FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

### Applications

- Motor control
- Converters
- Amplifiers
- Switches
- Power supply circuits
- Drivers (Relays, Hammers, Solenoids, Lamps, Memories, Displays, Bipolar Transistors, etc.)

### Package Options

(Note 1)



Note 1: See Package Outline section for discrete pinouts.

### Absolute Maximum Ratings

Drain-to-Source Voltage	$BV_{DSS}$
Drain-to-Gate Voltage	$BV_{DGS}$
Gate-to-Source Voltage	$\pm 20V$
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

\*Distance of 1.6 mm from case for 10 seconds.

## Thermal Characteristics

Package	$I_D$ (continuous)*	$I_D$ (pulsed)*	Power Dissipation @ $T_C = 25^\circ\text{C}$	$\theta_{jc}$ °C/W	$\theta_{ja}$ °C/W	$I_{DR}$	$I_{DRM}^*$
TO-3	2.5A	5.0A	100W	1.25	30	2.5A	5.0A
TO-39	0.35A	4.5A	6W	20.8	125	0.35A	4.5A
TO-220	1.5A	5.0A	50W	2.5	40	1.5A	5.0A

\* $I_D$  (continuous) is limited by max rated  $T_j$

## Electrical Characteristics (@ 25°C unless otherwise specified)

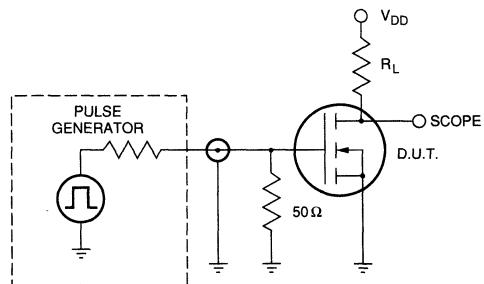
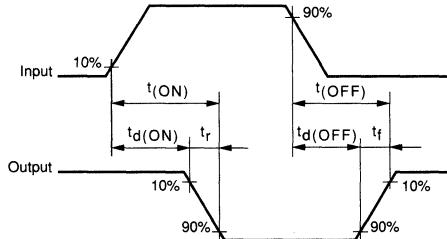
(Notes 1 and 2)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	VN0350	500		V	$V_{GS} = 0, I_D = 10\text{mA}$
		VN0345	450			
$V_{GS(th)}$	Gate Threshold Voltage	2		4	V	$V_{GS} = V_{DS}, I_D = 10\text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		-7	-9	mV/°C	$V_{GS} = V_{DS}, I_D = 10\text{mA}$
$I_{GSS}$	Gate Body Leakage			100	nA	$V_{GS} = \pm 20\text{V}, V_{DS} = 0$
$I_{DSS}$	Zero Gate Voltage Drain Current			100	μA	$V_{GS} = 0, V_{DS} = \text{Max Rating}$
				2	mA	$V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(ON)}$	ON-State Drain Current		3.5		A	$V_{GS} = 5\text{V}, V_{DS} = 25\text{V}$
		2	4.5			$V_{GS} = 10\text{V}, V_{DS} = 25\text{V}$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance		3.5		Ω	$V_{GS} = 5\text{V}, I_D = 0.5\text{A}$
			2.8	4		$V_{GS} = 10\text{V}, I_D = 0.5\text{A}$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature		1	1.5	%/°C	$V_{GS} = 10\text{V}, I_D = 0.5\text{A}$
$G_{FS}$	Forward Transconductance	500	1000		mΩ	$V_{DS} = 25\text{V}, I_D = 0.5\text{A}$
$C_{ISS}$	Input Capacitance		550	650		$V_{GS} = 0, V_{DS} = 25\text{V}$ $f = 1 \text{ MHz}$
$C_{OSS}$	Common Source Output Capacitance		50	75	pF	
$C_{RSS}$	Reverse Transfer Capacitance		15	25		
$t_{d(ON)}$	Turn-ON Delay Time		8	15		$V_{DD} = 25\text{V}$ $I_D = 1\text{A}$ $R_S = 50\Omega$
$t_r$	Rise Time		8	15	ns	
$t_{d(OFF)}$	Turn-OFF Delay Time		65	100		
$t_f$	Fall Time		15	25		
$V_{SD}$	Diode Forward Voltage Drop		1.3	1.8	V	$V_{GS} = 0, I_{SD} = 1\text{A}$
$t_{rr}$	Reverse Recovery Time		450		ns	$V_{GS} = 0, I_{SD} = 0.5\text{A}$

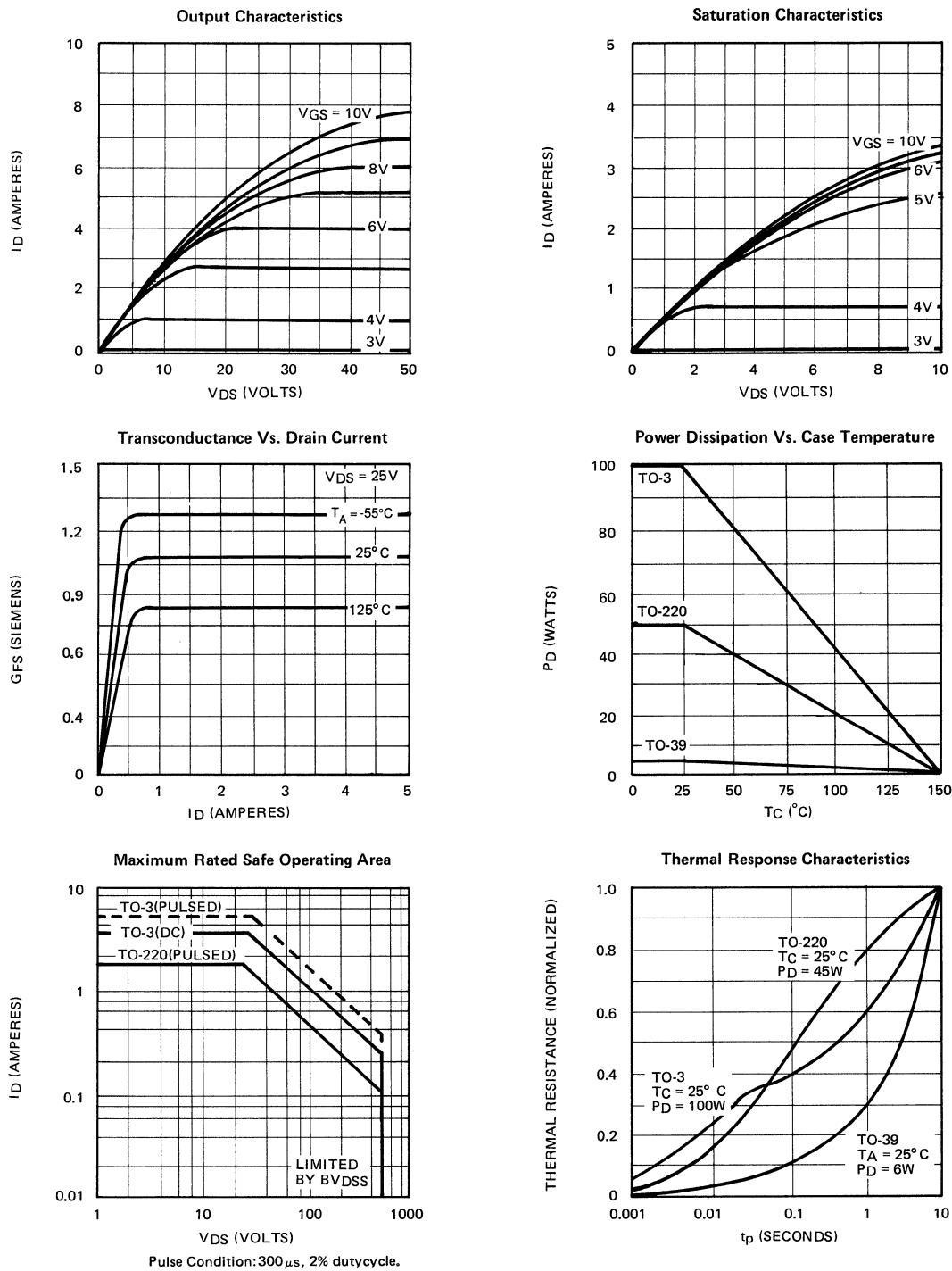
Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)

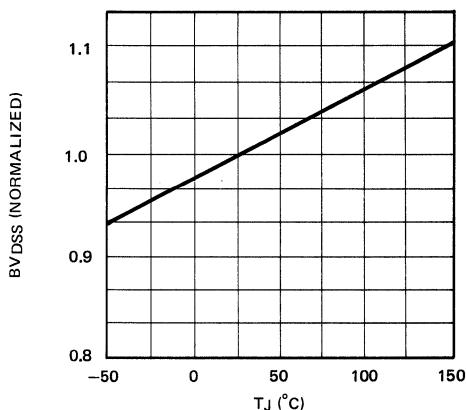
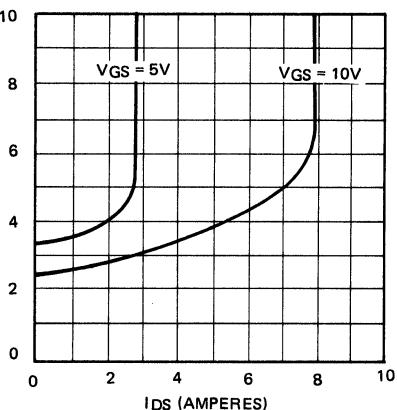
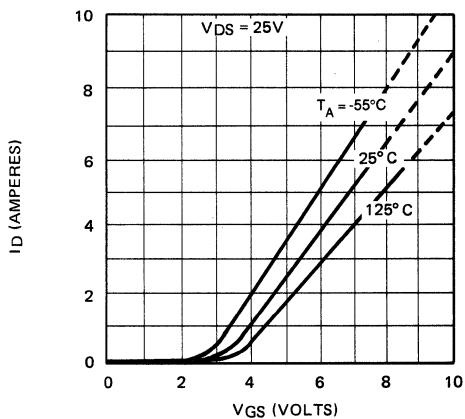
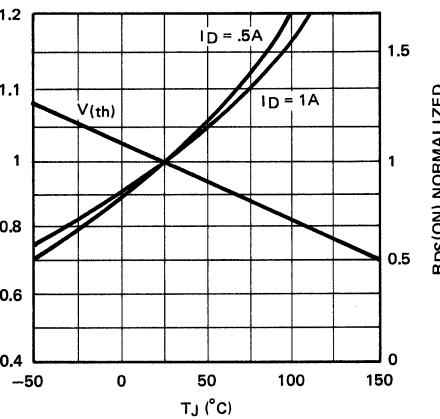
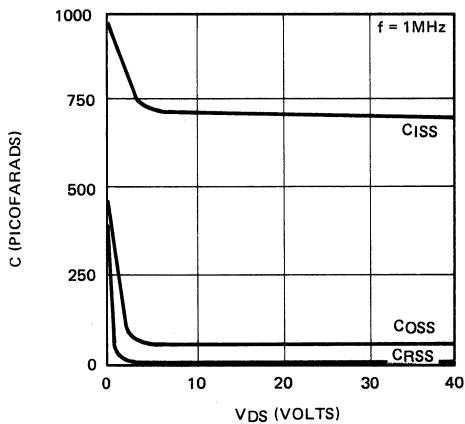
Note 2: All A.C. parameters sample tested.

## Switching Waveforms and Test Circuit



# Typical Performance Curves



**BVDSS Variation with Temperature****ON - Resistance Vs. Drain Current****Transfer Characteristics****V(th) and RDS Variation with Temperature****Capacitance Vs. Drain-to-Source Voltage****Gate Drive Dynamic Characteristics**